

Electronic Acknowledgement Receipt

EFS ID:	1381775
Application Number:	10820576
International Application Number:	
Confirmation Number:	8571
Title of Invention:	System and method for sharing confidential semiconductor manufacturing information using transitory links
First Named Inventor/Applicant Name:	Cheng-Hui Chiu
Customer Number:	42717
Filer:	David M. Odell/Bonnie Boyle
Filer Authorized By:	David M. Odell
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
1	Amendment - After Non-Final Rejection	85Response.pdf	313777	no	9

Warnings:

Information:**Total Files Size (in bytes):**

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New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.